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Submission Type: Utility Patent
Filing

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Number:

39.002-
AG

WAFER INCLUDING AN In- CONTAINING-COMPOUND SEMICONDUCTOR SURFACE LAYER, AND METHOD FOR PROFILING ITS CARRIER CONCENTRATION

First Named Inventor: Mr. Shigeru Sawada

SUBMITTED BY

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<jj>UDGE	

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Attached Files:

declaration	Declaration1.tif
declaration	Declaration2.tif
declaration	Declaration3.tif
specification	SM001spec.xml
bibd-transmittal	SM001apds.xml
patent-assignments	SM001asgn.xml
fee-transmittal	SM001fee.xml

Attached Image File(s):

Declaration1.tif
Declaration2.tif
Declaration3.tif

Comments:

FEE TRANSMITTAL

Electronic Version 1.1.0

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Patent fees are subject to annual revisions on or about October 1st of each year.

Large Entity

TOTAL FEES AUTHORIZED: \$ 780

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BASIC FILING FEE

Fee Description	Fee Code	Fee Paid
Utility Filing Fee	1001	\$ 740

Subtotal For Basic Filing Fee: \$ 740

EXTRA CLAIM FEES

	Fee Code	Fee	Extra Claims	Fee Paid
Total Claims: 13	1202	\$ 18	0	\$ 0
Independent Claims: 3	1201	\$ 84	0	\$ 0


Subtotal For Extra Claims Fees: \$ 0

ADDITIONAL FEES

Fee Description	Number	Quantity	Fee Code	Amount	Fee Paid
Recording Each Patent Assignment Per Property Fee	00000000	1	8021	\$ 40	\$ 40

Subtotal For Additional Fees: \$ 40

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Electronic Patent Application Submission
USPTO Use Only

EFS ID:	19321	
Application ID:	10065552	
Title of Invention:	WAFER INCLUDING AN In-CONTAINING-COMPOUND SEMICONDUCTOR SURFACE LAYER, AND METHOD FOR PROFILING ITS CARRIER CONCENTRATION	
First Named Inventor:	Shigeru Sawada	
Domestic/Foreign Application:	Domestic Application	
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Figures